

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	190	(clamp\$1 or pin\$1) with (spin\$4 and dry\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/02 10:34
L2	9	((clamp\$1 or pin\$1) and (spin\$4 and dry\$3) and wafer).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/02 10:35
L3	20	((clamp\$1 or pin\$1) and (spin\$4 or rotat\$3) and dry\$3 and wafer).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/02 10:37
L4	21	((clamp\$1 or pin\$1) and (spin\$4 or rotat\$3) and dry\$3 and wafer)	JPO	OR	OFF	2005/02/02 10:37
S1	2549	(118/728).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/02 10:24
S2	937	(118/729).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:28
S3	1431	(118/730).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:28
S4	417	(156/345.51).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:29
S5	99	(156/345.54).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:29
S6	88	(156/345.55).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:29

S7	383	(S1 or S2 or S3 or S4 or S5 or S6) and clamp\$3 and rotat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:33
S8	42	(S1 or S2 or S3 or S4 or S5 or S6) and (clamp\$3 and rotat\$3).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:31
S9	12	(S1 or S2 or S3 or S4 or S5 or S6) and (clamp\$3 and rotat\$3 and pin\$1).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:34
S10	149	(156/345.23).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:32
S11	20	S10 and clamp\$3 and rotat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:33
S12	629	((wafer or substrate) and clamp\$3 and rotat\$3).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:35
S13	408	((wafer or substrate) and (second adj (clamp\$3 or rotat\$3))).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:37
S14	3	((wafer or substrate) and (second adj (clamp\$3 and rotat\$3))).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 12:28
S15	893	(wafer and clamp\$3).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:40
S16	608	(wafer and clamp\$3).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:41

S17	520	(S15 or S16) and rotat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:41
S18	934	S17 or S12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:43
S19	305	(216/91).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:43
S20	19	S19 and clamp\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/12 15:43
S21	4	((("6551488") or ("4489740")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/18 12:59
S22	686	(wafer and (clamp\$3 or pin\$1 or cam\$1) and (rotary or rotat\$4)). clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 12:30
S23	480	(wafer and (clamp\$3 or pin\$1 or cam\$1) and (rotary or rotat\$4))	JPO	OR	OFF	2005/01/31 13:45
S24	448	(S22 or S23) and (wafer near2 rotat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 12:31
S25	337	S22 and (wafer near2 rotat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 12:37
S26	111	S23 and (wafer near2 rotat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 12:31
S27	189	S24 not (vacuum or chuck)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 13:47

S28	1471	(wafer and (clamp\$3 or pin\$1 or cam\$1 or chuck) and (rotary or rotat\$4))	JPO	OR	OFF	2005/02/01 16:01
S29	1121	(wafer and (clamp\$3 or pin\$1 or cam\$1 or chuck) and (rotary or rotat\$4)).clm.	US-PGPUB; USPAT	OR	OFF	2005/01/31 13:46
S30	686	(wafer and (clamp\$3 or pin\$1 or cam\$1) and (rotary or rotat\$4)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 13:47
S31	480	(wafer and (clamp\$3 or pin\$1 or cam\$1) and (rotary or rotat\$4))	JPO	OR	OFF	2005/01/31 13:47
S32	448	(S30 or S31) and (wafer near2 rotat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 13:47
S33	234	S32 not vacuum	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 14:11
S34	2	("6683007").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 14:16
S35	2	"2001118824"	JPO; DERWENT	OR	OFF	2005/01/31 14:18
S36	1	2001-386337.NRAN.	DERWENT	OR	OFF	2005/01/31 14:17
S37	2	("6683007").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 14:39
S38	8	((("5861066") or ("5546094") or ("5801662") or ("5204687"))).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/31 14:39
S39	13	("5032217" "5204687" "5520205" "5546094" "5779816" "5801662" "5861066" "6063232" "6155275" "6202658" "6260562" "6299697" "6494221").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/31 14:40
S40	39	(pin adj chuck).clm.	US-PGPUB; USPAT	OR	OFF	2005/02/01 16:04
S41	31	(pin adj chuck)	JPO	OR	OFF	2005/02/01 16:02

S42	70	S41 or S40	US-PGPUB; USPAT; JPO	OR	OFF	2005/02/01 16:02
S43	381	((hold\$3 near2 wafer) and (pin\$1 or cam\$1 or clamp\$3)).clm.	US-PGPUB; USPAT	OR	OFF	2005/02/01 16:05
S44	4	"2003088793"	JPO; DERWENT	OR	OFF	2005/02/01 16:46
S45	1	2003-323828.NRAN.	DERWENT	OR	OFF	2005/02/01 16:42
S46	237	dainippon.as. and kaoru.in.	JPO	OR	OFF	2005/02/01 16:47
S47	3	dainippon.as. and kaoru.in. and pin\$1	JPO	OR	OFF	2005/02/01 16:48
S48	635	dainippon.as. and pin\$1	JPO	OR	OFF	2005/02/01 16:48
S49	38	dainippon.as. and pin\$1 and wafer	JPO	OR	OFF	2005/02/01 16:48